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FDP39N20 / FDPF39N20 N-Channel UniFETTM MOSFET 200 V, 39 A, 66 mΩ

Features

- R_{DS(on)} = 66 mΩ (Max.) @ V_{GS} = 10 V, I_D = 19.5 A
- Low Gate Charge (Typ. 38 nC)
- Low C_{rss} (Typ. 57 pF)
- 100% Avalanche Tested

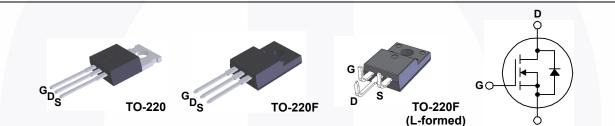
Applications

- PDP TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

August 2014

Description

UniFETTM MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter		FDP39N20	FDPF39N20 / FDPF39N20TLDTU	Unit
V _{DSS}	Drain-Source Voltage			200		
ID	Drain Current	- Continuous ($T_C = 25^{\circ}C$) - Continuous ($T_C = 100^{\circ}C$)		39 23.4	39 * 23.4 *	A A
I _{DM}	Drain Current	- Pulsed	(Note 1)	156	156 *	Α
V _{GSS}	Gate-Source voltage			±30		
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	860		
I _{AR}	Avalanche Current		(Note 1)	39		
E _{AR}	Repetitive Avalanche Energy		(Note 1)	25.1		
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.5		
P _D	Power Dissipation	(T _C = 25°C) - Derate Above 25°C		251 2.0	37 0.29	W W/°C
T _{J,} T _{STG}	Operating and Storage Temperature Range			-55 to +150		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300		

Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FDP39N20	FDPF39N20 / FDPF39N20TLDTU	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.5	3.4	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	0/10	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDP39N20	FDP39N20	TO-220	Tube	N/A	N/A	50 units
FDPF39N20	FDPF39N20	TO-220F	Tube	N/A	N/A	50 units
FDPF39N20TLDTU	FDPF39N20T	TO-220F (L-formed)	Tube	N/A	N/A	50 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain-Source Breakdown Voltage $V_{GS} = 0 V, I_D = 250 \mu A$		200			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		0.2		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 200 V, V_{GS} = 0 V$ $V_{DS} = 160 V, T_{C} = 125^{\circ}C$			1 10	μΑ μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Charac	teristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 19.5 A		0.056	0.066	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 19.5 A		28.5		S
Dynamic C	Characteristics					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz		1640	2130	pF
C _{oss}	Output Capacitance			400	520	pF
C _{rss}	Reverse Transfer Capacitance			57	85	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time	V_{DD} = 100 V, I _D = 39 A, V _{GS} = 10 V, R _G = 25 Ω		30	70	ns
t _r	Turn-On Rise Time			160	330	ns
t _{d(off)}	Turn-Off Delay Time			150	310	ns
t _f	Turn-Off Fall Time	(Note 4)		150	310	ns
Qg	Total Gate Charge	V _{DS} = 160 V, I _D = 39 A,		38	49	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V		11		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		16.5		nC
Drain-Sou	rce Diode Characteristics and Maximur	n Ratings			1	
I _S	Maximum Continuous Drain-Source Diode Forward Current				39	А
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				156	А
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 39 A			1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 39 A,		152		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt =100 Å/μs		1.1		μC

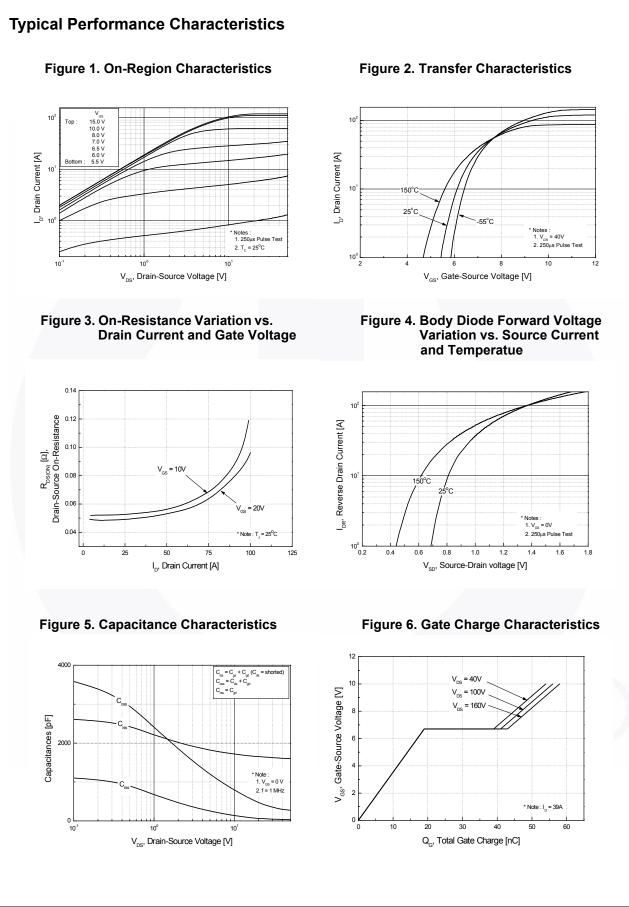
Notes:

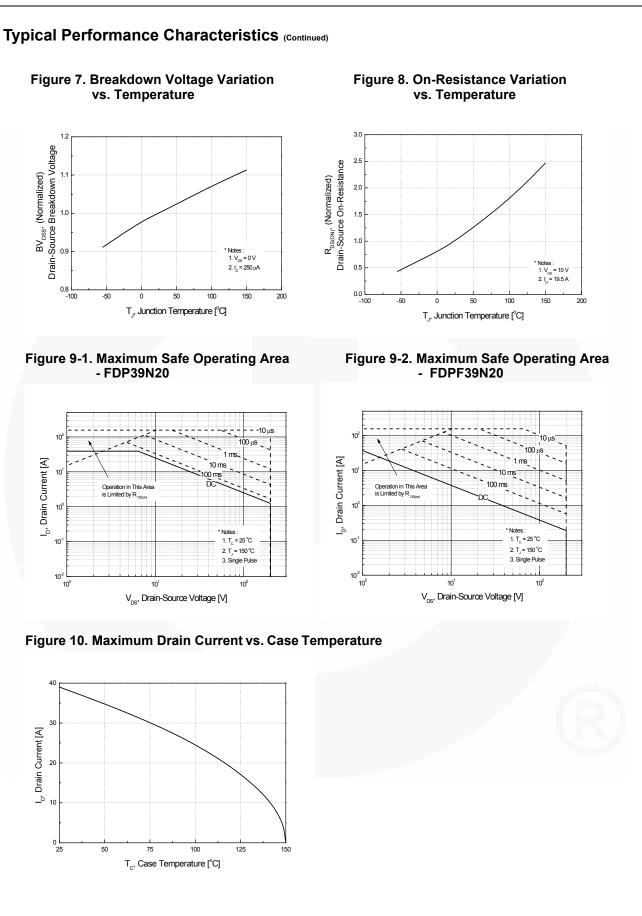
1. Repetitive rating: pulse-width limited by maximum junction temperature.

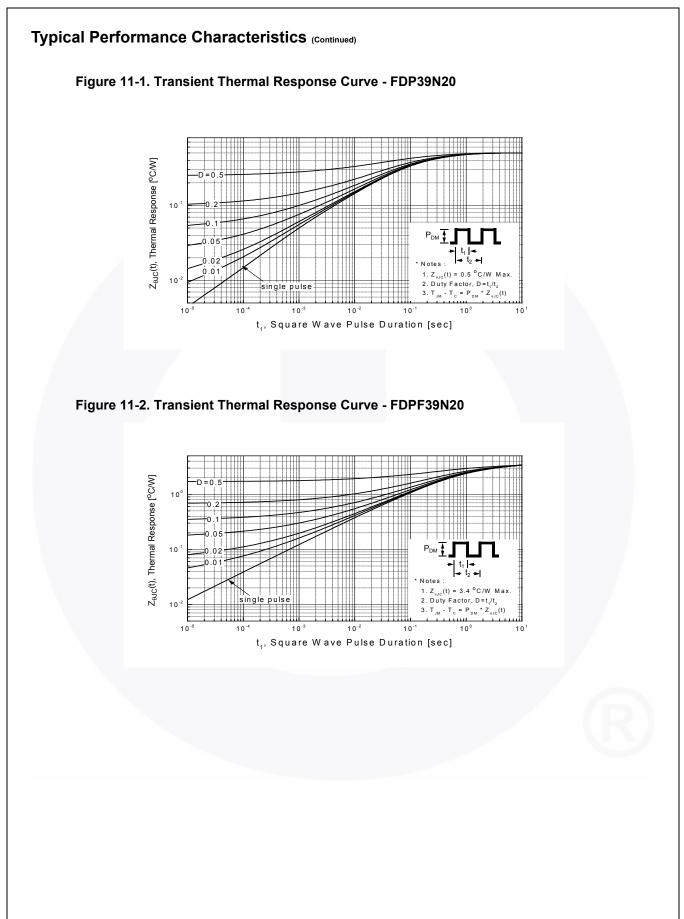
2. L = 0.85 mH, I_{AS} = 39 A, V_{DD} = 50 V, R_G = 25 $\Omega,$ starting T_J = 25°C.

3. I_{SD} \leq 39 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS}, starting T_J = 25°C.

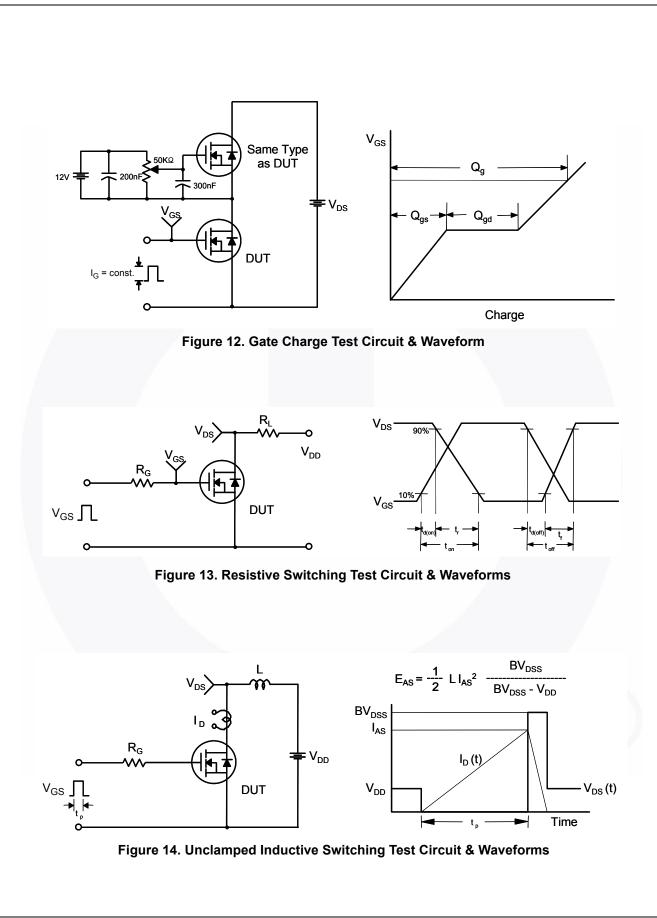
4. Essentially independent of operating temperature typical characteristics.



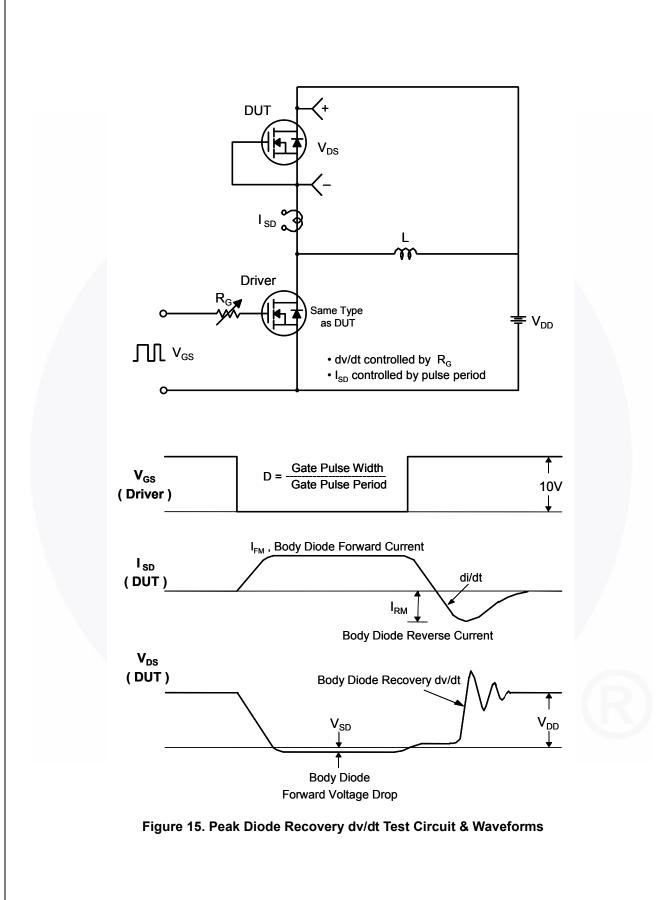


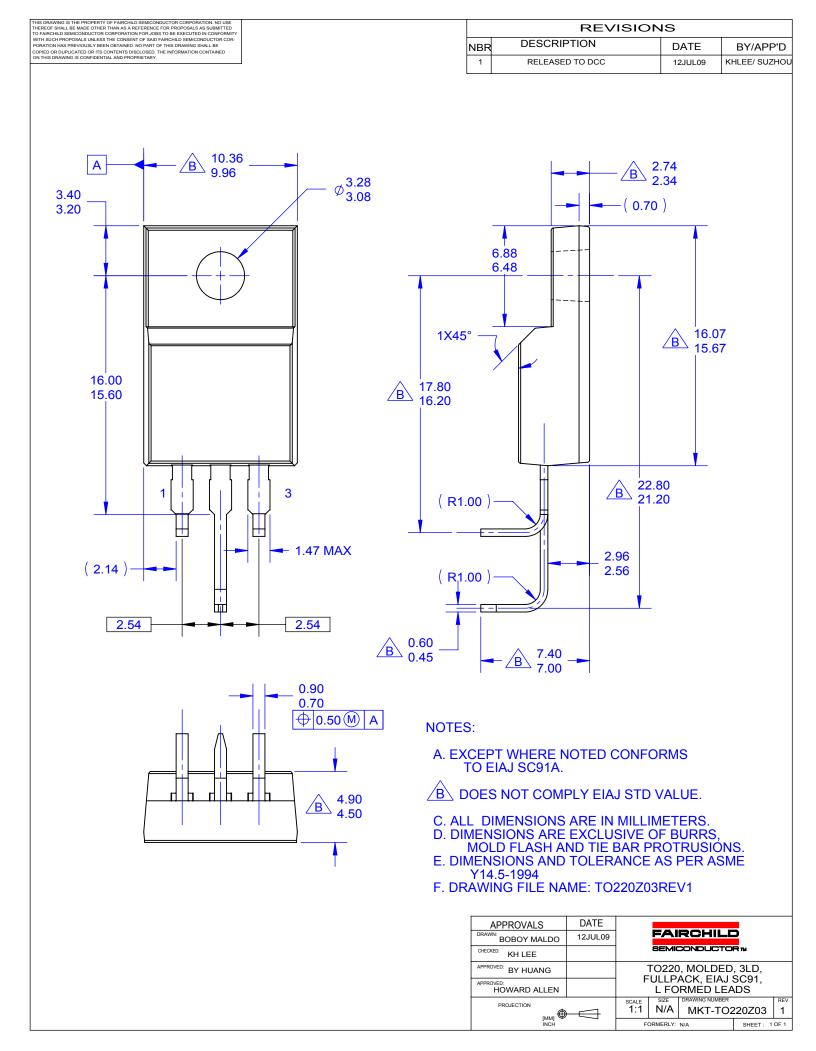


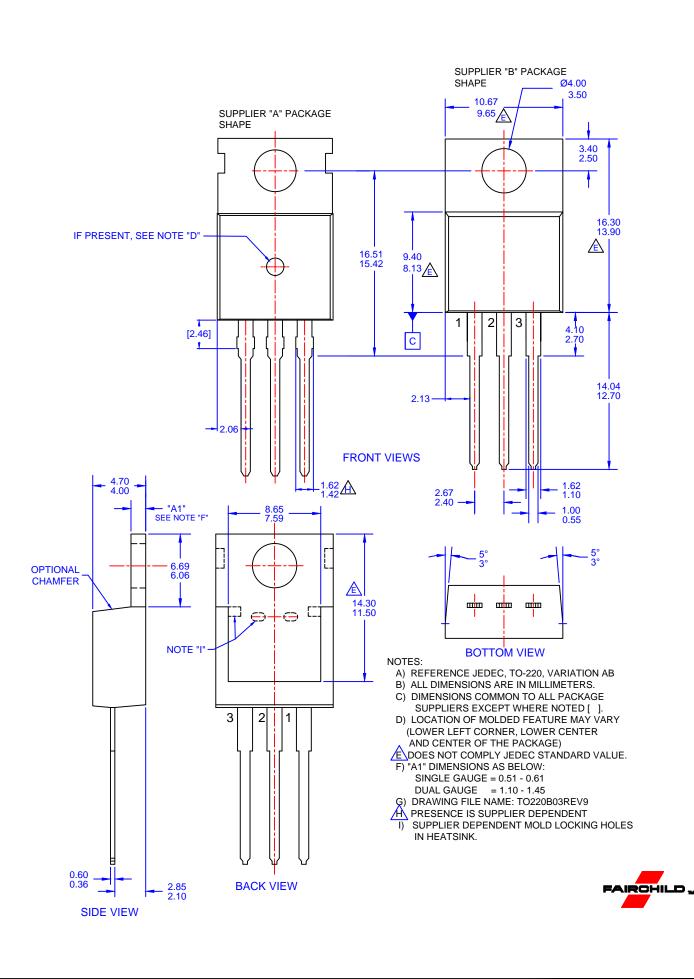
FDP39N20 / FDPF39N20 — N-Channel UniFETTM MOSFET

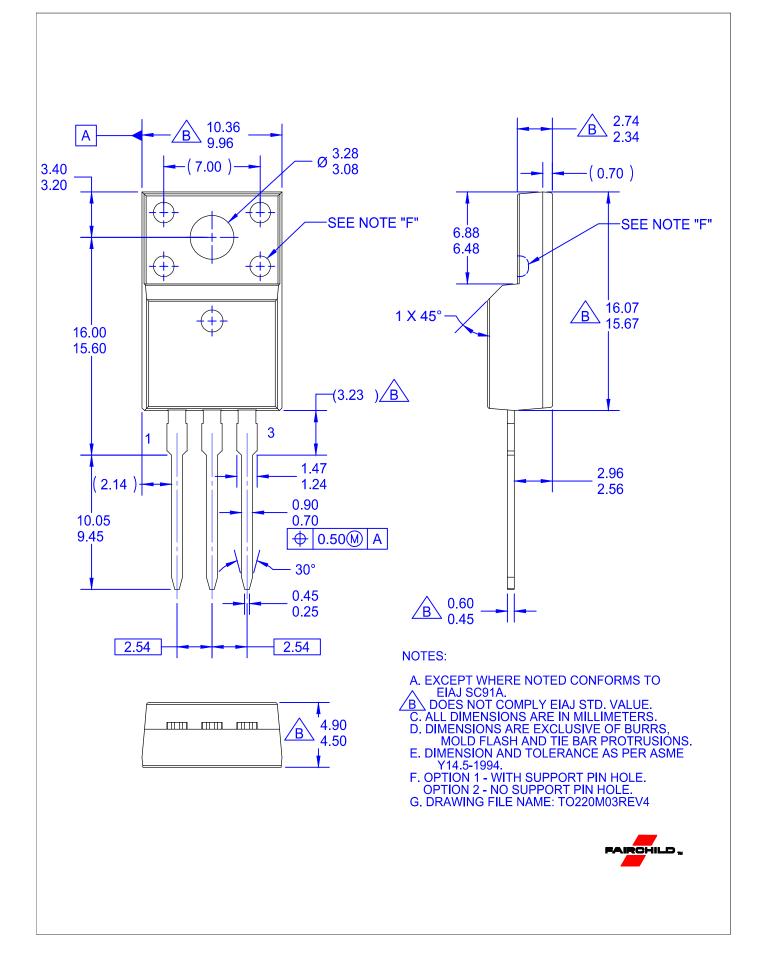


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